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(73) Proprietor: **International Business Machines Corporation**
Old Orchard Road
Armonk, N.Y. 10504 (US)

(72) Inventor: **Barclay, Donald John**
1a Broadview Lane
Oliver's Battery Winchester Hampshire (GB)
Inventor: **Morgan, William Morris**
7 Keble Road
Chandler's Ford Eastleigh Hampshire (GB)
Inventor: **Vigar, James Michael Linford**
25 Compton Way
Oliver's Battery Winchester Hampshire (GB)

(74) Representative: **Mitchell, Allan Edmund**
IBM United Kingdom Patent Operations Hursley Park
Winchester, Hants, SO21 2JN (GB)

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Description

Introduction

The invention relates to the electrodeposition of chromium and its alloys from electrolytes containing trivalent chromium ions.

Background Art

Commercially chromium is electroplated from electrolytes containing hexavalent chromium, but many attempts over the last fifty years have been made to develop a commercially acceptable process for electroplating chromium using electrolytes containing trivalent chromium salts. The incentive to use electrolytes containing trivalent chromium salts arises because hexavalent chromium presents serious health and environmental hazards — it is known to cause ulcers and is believed to cause cancer, and, in addition, has technical limitations including the cost of disposing of plating baths and rinse water.

The problems associated with electroplating chromium from solutions containing trivalent chromium ions are primarily concerned with reactions at both the anode and cathode. Other factors which are important for commercial processes are the material, equipment and operational costs.

In order to achieve a commercial process, the precipitation of chromium hydroxy species at the cathode surface must be minimised to the extent that there is a sufficient supply of dissolved i.e. solution-free, chromium (III) complexes at the plating surface; and the reduction of chromium ions promoted. United Kingdom Patent specification 1,431,639 describes a trivalent chromium electroplating process in which the electrolyte comprises aquo chromium (III) thiocyanato complexes. The thiocyanate ligand stabilises the chromium ions inhibiting the formation of precipitated chromium (III) salts at the cathode surface during plating and also promotes the reduction of chromium (III) ions. United Kingdom Patent specification 1,591,051 described an electrolyte comprising chromium thiocyanato complexes in which the source of chromium was a cheap and readily available chromium (III) salt such as chromium sulphate.

Improvements in performance i.e., the efficiency or plating rate, plating range and temperature range were achieved by the addition of a complexant which provided one of the ligands for the chromium thiocyanato complex. These complexants, described in United Kingdom Patent specification 1,596,995, comprised amino acids such as glycine and aspartic acid, formates, acetates or hypophosphites. The improvement in performance depended on the complexant ligand used. The complexant ligand was effective at the cathode surface to further inhibit the formation of precipitated chromium (III) species. In specification 1,596,995 it was noticed that the improvement in performance permitted a substantial reduction in the concentration of chromium ions in the electrolyte without ceasing to be a commercially viable process. In United Kingdom Patent specifications 2,033,427 and 2,038,361 practical electrolytes comprising chromium thiocyanato complexes were described which contained less than 30 mM chromium ions — the thiocyanate and complexant being reduced in proportion. The reduction in chromium concentration had two desirable effects, firstly the treatment of rinse waters was greatly simplified and, secondly, the colour of the chromium deposit was much lighter.

Oxidation of chromium and other constituents of the electrolyte at the anode are known to progressively and rapidly inhibit plating. Additionally some electrolytes result in anodic evolution of toxic gases. An electroplating bath having an anolyte separated from a catholyte by a perfluorinated cation exchange membrane, described in United Kingdom Patent Specification 1,602,404, successfully overcomes these problems. Alternatively an additive, which undergoes oxidation at the anode in preference to chromium or other constituents, can be made to the electrolyte. A suitable additive is described in United Kingdom Patent specification 2,034,354. The disadvantage of using an additive is the ongoing expense.

United Kingdom Patent specification 1,488,381 describes an electrolyte for electroplating chromium in which thiourea is suggested as a complexant either singly or in combination with other compounds for stabilising trivalent chromium ions, but no specific example or experimental results were given.

Disclosure of the Invention

Three related factors are responsible for many of the problems associated with attempts to plate chromium from trivalent electrolytes. These are, a negative plating potential which results in hydrogen evolution accompanying the plating reaction, slow electrode kinetics and the propensity of chromium (III) to precipitate as hydroxy species in the high pH environment which exists at the electrode surface. The formulation of the plating electrolytes of the present invention described herein are based on an understanding of how these factors could be contained.

Cr (III) ions can form a number of complexes with ligands, L, characterised by a series of reactions which may be summarised as:

$$Cr + L = CrL \qquad K_1$$

$$CrL + L = CrL_2 \qquad K_2$$

.....

.....

etc.

where charges are omitted for convenience and K_1, K_2, ... etc. are the stability constants and are calculated from:

$K_1 = [CrL]/[Cr][L]$

$K_2 = [CrL_2]/[CrL][L]$

.....

.....

etc.

where the square brackets represent concentrations. Numerical values may be obtained from (1) "Stability Constants of Metal-Ion Complexes", Special Publication No. 17, The Chemical Society, London 1964 — L. G. Sillen and A. E. Martell; (2) "Stability Constants of Metal-Ion Complexes", Supplement No. 1, Special Publication No. 25, The Chemical Society, London 1971 — L. G. Sillen and A. E. Martell; (3) "Critical Stability Constants", Vol. 1 and 2, Plenum Press, New York 1975 — R. M. Smith and A. E. Martell. The ranges for K given in the above references should be recognised as being semi-quantitative, especially in view of the spread of reported results for a given system and the influence of the ionic composition of the electrolyte. Herein K values as taken at 25°C.

During the plating process the surface pH can rise to a value determined by the current density and the acidity constant, pKa, and concentration of the buffer agent (e.g. boric acid). This pH will be significantly higher than the pH in the bulk of the electrolyte and under these conditions chromium-hydroxy species may precipitate. The value of K_1, K_2, ... etc. and the total concentrations of chromium (III) and the complexant ligand determine the extent to which precipitation occurs; the higher the values of K_1, K_2, ... etc. the less precipitation will occur at a given surface pH. As plating will occur from solution-free (i.e. non-precipitated) chromium species higher plating efficiencies may be expected from ligands with high K values.

However, a second consideration is related to the electrode potential adopted during the plating process. If the K values are too high plating will be inhibited because of the thermodynamic stability of the chromium complexes. Thus selection of the optimum range for the stability constants, and of the concentrations of chromium and the ligand, is a compromise between these two opposing effects: a weak complexant results in precipitation at the interface, giving low efficiency (or even blocking of plating by hydroxy species), whereas too strong a complexant inhibits plating for reasons of excessive stability.

A third consideration is concerned with the electrochemical kinetics of the hydrogen evolution reaction (H.E.R) and of chromium reduction. Plating will be favoured by fast kinetics for the latter reaction and slow kinetics for the H.E.R. Thus additives which enhance the chromium reduction process or retard the H.E.R. will be beneficial with respect to efficient plating rates. It has been found that many sulphur containing species having —C=S or —C—S— groups favour the reduction of chromium (III) to chromium metal.

The present invention provides a chromium electroplating electrolyte containing trivalent chromium ions, a complexant, a buffer agent and organic compound having a —C=S group or a —C—S— group within the molecule for promoting chromium deposition, the complexant being selected so that the stability constant K_1 of the reaction between the chromium ions and the complexant is in the range $10^8 < K_1 < 10^{12}$ M^{-1} at about 25°C, and the organic compound being selected from thiourea, N-monoallyl thiourea, N-mono-p-tolyl thiourea, thioacetamide, tetramethyl thiuram monosulphide, tetraethyl thiuram disulphide, diethyldithiocarbamate, mercaptoacetic and/or mercaptopropionic acid.

By way of example complexant ligands having K_1 values within the range $10^8 < K_1 < 10^{12}$ M^{-1} include aspartic acid, iminodiacetic acid, nitrilotriacetic acid and 5-sulphosalicylic acid.

Very low concentrations of the organic compound are needed to promote reduction of the trivalent chromium ions. Also since the plating efficiency of the electrolyte is relatively high a commercial trivalent chromium electrolyte can have as low as 5 mM chromium. This removes the need for expensive rinse water treatment since the chromium content of the 'drag-out' from the plating electrolyte is extremely low.

In general the concentration of the constituents in the elecrolyte are as follows:

Chromium (III) ions	10^{-3} to 1M
Organic compound	10^{-5} to 10^{-2} M

A practical chromium/complexant ligand ratio is approximately 1:1.

Above a minimum concentration necessary for acceptable plating rates, it is unnecessary to increase the amount of the organic compound in proportion to the concentration of chromium in the electrolyte. Excess of the organic compound may not be harmful to the plating process but can result in an increased amount of sulphur being co-deposited with the chromium metal. This has two effects, firstly to produce a progressively darker deposit and, secondly, to produce a more ductile deposit.

The preferred source of trivalent chromium is chromium sulphate which can be in the form of a commercially available mixture of chromium and sodium sulphates known as tanning liquor or chrometan. Other trivalent chromium salts, which are more expensive than the sulphate, can be used, and include chromium chloride, carbonate and perchlorate.

The preferred buffer agent used to maintain the pH of the bulk electrolyte comprises boric acid in high concentrations i.e., near saturation. Typical pH range for the electrolyte is in the range 2.5 to 4.5.

The conductivity of the electrolyte should be as high as possible to minimise both voltage and

power consumption. Voltage is often critical in practical plating environments since rectifiers are often limited to a low voltage, e.g. 8 volts. In an electrolyte in which chromium sulphate is the source of the trivalent chromium ions a mixture of sodium and potassium sulphate is the optimum in order to increase conductivity. Such a mixture is described in United Kingdom Patent specification 2,071,151, which corresponds to EP—A—0035667.

A wetting agent is desirable and a suitable wetting agent is FC98, a product of the 3M Corporation. However other wetting agents such as sulphosuccinates or alcohol sulphates may be used.

It is preferred to use a perfluorinated cation exchange membrane to separate the anode from the plating electrolyte as described in United Kingdom Patent specification 1,602,404. A suitable perfluorinated cation exchange membrane is Naflon (Registered Trade Mark) a product of the Du Pont Corporation. It is particularly advantageous to employ an anolyte which has sulphate ions when the catholyte uses chromium sulphate as the source of chromium since inexpensive lead or lead alloy anodes can be used. In a sulphate anolyte a thin conducting layer of lead oxide is formed on the anode. Chloride salts in the catholyte should be avoided since the chloride anions are small enough to pass through the membrane in sufficient amount to cause both the evolution of chlorine at the anode and the formation of a highly resistive film of lead chloride on lead or lead alloy anodes. Cation exchange membranes have the additional advantage in sulphate electrolytes that the pH of the cathode can be stabilised by adjusting the pH of the anolyte to allow the hydrogen ion transport through the membrane to compensate for the increase in pH of the catholyte by hydrogen evolution at the cathode. Using the combination of a membrane, and sulphate based anolyte and catholyte a plating bath has been operated for over 40 Amphours/litre without pH adjustment.

Detailed Description

The invention will now be described with reference to detailed Examples. In each Example a bath consisting of anolyte separated from a catholyte by a Nafion cation exchange membrane is used. The anolyte comprises an aqueous solution of sulphuric acid in 2% by volume concentration (pH 1.6). The anode is a flat bar of a lead alloy of the type conventionally used in hexavalent chromium plating processes.

The catholyte for each Example was prepared by making up a base electrolyte and adding appropriate amounts of chromium (III), complexant and the organic compound.

The base electrolyte consisted of the following constituents dissolved in 1 litre of water:

Potassium sulphate	1 M
Sodium sulphate	0.5 M
Boric acid	1M
Wetting agent FC98	0.1 gram

Example 1

The following constituents were dissolved in the base electrolyte :

Chromium (III)	10 mM (from chrometan)
DL aspartic acid	10 mM
Thiourea	1 mM
at pH	3.5

Although equilibration will occur quickly in normal use, initially the electrolyte is preferably equilibrated until there are no spectroscopic changes which can be detected. The bath was to operate over a temperature range of 25 to 60°C. Good bright deposits of chromium were obtained over current density of 5 to 800 mA/cm^2.

Example 2

The following constituents were dissolved in the base electrolyte:

Chromium (III)	10 mM (from chrometan)
Iminodiacetic acid	10 mM
Thiourea	1 mM
at pH	3.5

The electrolyte is preferably equilibrated until there are no spectroscopic changes. The bath was found to operate over a temperature range of 25 to 60°C. Good bright deposits of chromium were obtained.

Example 3

The following constituents were dissolved in the base electrolyte:

Chromium (III)	100 mM (from chrometan)
DL Aspartic acid	100 mM
Mercaptoacetic acid	1 mM
at pH	3.5

The electrolyte is preferably equilibrated until there are no spectroscopic changes. The bath was found to operate over a temperature range of 25 to 60°C. Good bright deposits were obtained.

Example 4

The following constituents were dissolved in the base electrolyte:

Chromium (III)	100 mM (from chrometan)
DL Aspartic acid	100 mM
Thiourea	1 mM
at pH	3.5

The electrolyte is preferably equilibrated until there are no spectroscopic changes. The bath was found to operate over a temperature range of 25 to 60°C. Good bright deposits were obtained over a current density range of 10 to 800 mA/cm^2.

By way of comparison when the complexant aspartic acid in this Example is replaced with citric acid, the stability constant K_1 of which is less than 10^8, the plating efficiency is less than one half that with aspartic acid.

Claims

1 A chromium electroplating electrolyte containing trivalent chromium ions, a complexant, a buffer agent and organic compound having a —C=S group or a —C—S— group within the molecule for promoting chromium deposition, the complexant being distinguished from said organic compound and selected so that the stability constant K_1 of the reaction between the chromium ions and the complexant is in the range $10^8 < K_1 < 10^{12}$ M^{-1} at about 25°C, and the organic compound being selected from thiourea, N-monoallyl thiourea, N-mono-p-tolyl thiourea, thioacetamide, tetramethyl thiuram monosulphide, tetraethyl thiuram disulphide, diethyldithioicarbamate, mercaptoacetic and/or mercaptopropionic acid.

2. An electrolyte as claimed in claim 1, in which the complexant is selected from aspartic acid, iminodiacetic acid, nitrilotriacetic acid or 5-sulphosalicylic acid.

3. An electrolyte as claimed in any one of the preceding claims, in which the buffer agent is boric acid.

4. An electrolyte as claimed in any one of the preceding claims, in which the source of chromium is chromium sulphate and including conductivity ions selected from sulphate salts.

5. An electrolyte as claimed in claim 4, in which the sulphate salts are a mixture of sodium and potassium sulphate.

6. A bath for electroplating chromium comprising an anolyte separated from a catholyte by a perfluorinated cation exchange membrane, the catholyte consisting of the electrolyte claimed in any one of the preceding claims.

7. A bath as claimed in claim 6, in which the anolyte comprises sulphate ions.

8. A bath as claimed in claim 6 or 7 including a lead or lead alloy anode immersed therein.

9. A process for electroplating chromium or a chromium alloy comprising passing an electric current between an anode and a cathode immersed in the electrolyte claimed in any one of claims 1 to 5 or in a bath as claimed in claims 6, 7, or 8.

Patentansprüche

1. Elektrolyt für die Elektroplattierung von Chrom, der dreiwertige Chromionen, einen Komplexbildner, ein Puffermittel und eine organische Verbindung mit einer —C=S—Gruppe oder eine —C—S—Gruppe innerhalb des Moleküls zur Aktivierung der Chromabscheidung enthält, wobei der Komplexbildner sich von der organischen Verbindung unterscheidet und so ausgewählt wird, daß die Stabilitätskonstante K_1 der Reaktion zwischen den Chromionen und dem Komplexbildner im Bereich von $10^8 < K_1 < M^{-1}$ bei etwa 25°C liegt, und wobei die organische Verbindung ausgewählt wird unter Thioharnstoff, N-Monoallylthioharnstoff, N-Mono-p-tolylthioharnstoff, Thioacetamid, Tetramethylthiurammonosulfid, Tetraethylthiuramdisulfid, Diethyldithiocarbamat, Mercaptoessig- und/oder Mercaptopropionsäure.

2. Elektrolyt nach Anspruch 1, bei dem der Komplexbildner ausgewählt wird unter Asparaginsäure, Iminodiessigsäure, Nitrilotriessigsäure oder 5-Sulfosalicylsäure.

3. Elektrolyt nach einem der vorhergehenden Ansprüche, wobei das Puffermittel Borsaure ist.

4. Elektrolyt nach einem der vorhergehenden Ansprüche, wobei die Chromquelle Chromsulfat ist und wobei er leitfähige Ionen, ausgewählt unter Sulfatsalzen, enthält.

5. Elektrolyt nach Anspruch 4, wobei die Sulfatsalze ein Gemisch aus Natrium- und Kaliumsulfat sind.

6. Bad für die Elektroplattierung von Chrom, welches einen Anolyten, der von einem Katholyten mittels einer perforierten Kationenauschmembran getrennt ist, enthält, wobei der Katholyt aus dem Elektrolyten nach einem der vorhergehenden Ansprüche besteht.

7. Bad nach Anspruch 6, wobei der Anolyt Sulfationen enthält.

8. Bad nach Anspruch 6 oder 7, welches darin eingetaucht eine Anode aus Blei oder Bleilegierung enthält.

9. Verfahren zur Elektroplattierung von Chrom oder einer Chromlegierung, wobei man einen elektrischen Strom zwischen einer Anode und einer Kathode, die in den Elektrolyten nach einem der Ansprüche 1 bis 5 oder in einem Bad nach einem der Ansprüche 6, 7 oder 8 eingetaucht sind, leitet.

Revendications

1. Electrolyte d'électro-chromage contenant des ions chrome trivalents, un complexant, un agent tampon et un composé organique comportant un groupe —C=S ou un groupe —C—S— dans la molécule, pour promouvoir le dépôt de chrome, le complexant étant distinct du dit composé organique et choisi de manière que la constante de stabilité K_1 de la réaction entre les ions chrome et

le complexant se trouve dans l'intervalle $10^8 < K_1 < 10^{12}$ M^{-1}, à environ 25°C, le composé organique étant choisi parmi la thiourée, la N-monoallyl thiourée, la N-mono-P-tolyl thiourée, la thioacétamide, le monosulfure de tétraméthyl thiurame, le disulfure de tetraéthyl thiurame, le diéthyldithiocarbamate, l'acide mercaptoacétique et/ou mercaptopropionique.

2. Electrolyte selon la revendication 1, dans lequel le complexant est choisi parmi l'acide aspartique, l'acide iminodiacétique, l'acide nitrilotriacétique et l'acide 5-sulfosalicylique

3. Electrolyte selon l'une quelconque des revendications précédentes, dans lequel l'agent tampon est l'acide borique.

4. Electrolyte selon l'une quelconque des revendications précédentes, dans lequel la source de chrome est le sulfate de chrome et qui comprend des ions de conductivité choisis permi les sels sulfates.

5. Electrolytes selon la revendication 4, dans lequel les sels sulfates sont constitués par un mélange de sulfates de sodium et de potassium.

6. Un bain d'électro-chromage comprenant un anolyte séparé d'un catholyte par une membrane échangeuse de cations perfluorée, le catholyte étant constitué par l'électrolyte défini à l'une quelconque des revendications précédentes.

7. Un bain selon la revendication 6, dans lequel l'anolyte comprend des ions sulfate.

8. Un bain selon la revendication 6 ou 7, dans lequel est immergée une anode en plomb ou en alliage de plomb.

9. Procédé pour le dépôt électrolytique de chrome ou d'alliage de chrome, dans lequel on fait passer un courant électrique entre une anode et une cathode immergées dans l'électrolyte défini à l'une des revendications 1 à 5 ou dans un bain selon l'une des revendications 6, 7 ou 8.